

FULLY AUTOMATIC LASER GROOVING MACHINE

AL3000



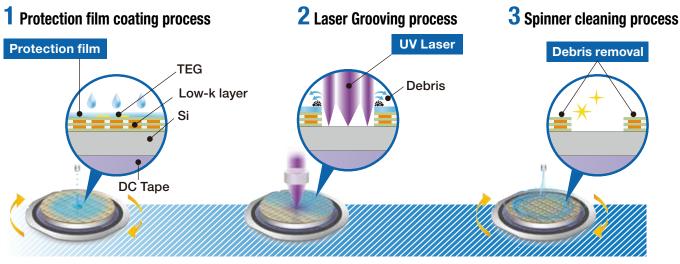
• Ø300mm Compatible fully automatic laser dicing machine Automatically supports a series of processes from water-soluble protective film distribution to laser dicing and cleaning.

- Laser Grooving Process compatible AL3000 supports applications for removing TEG on low-k grooves or streets.
- Achieves both high quality processing and high throughput with a unique laser engine mechanism

• Enhanced ease of use Intuitive operation is possible using the LCD touch panel and simpler screen configuration and iconization by GUI (Graphical User Interface).

TOKYO SEIMITSU CO., LTD.

Laser Grooving process



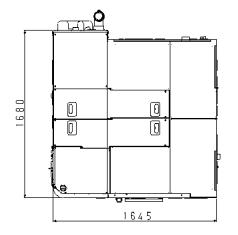
Specifications

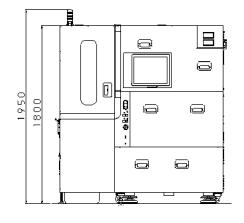
Model Name		AL3000
Processing method		Ablation
Laser oscillator		Semiconductor Laser excitation Q-Swith Solid-State Laser
Wavelength(nm)		355
Max. workpeice size(mm)		Ф305
Cutting stroke (mm)		310 x 310
X-axis	Max. Mooving speed(mm/sec)	1,000
Y-axis	Max. Mooving speed(mm/sec)	300
	Positioning accuracy (µm)	0.078
Z-axis	Max. Mooving speed(mm/sec)	10
	Repeatability accuracy (µm)	1.0
θ-axis	Max. rotaing angle(deg)	380.0

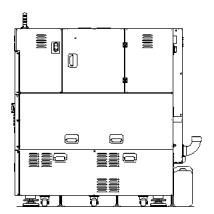
Power supply(V)	3-phase 200 \sim 220VAC±10% 50/60Hz (380, and 415 V are available with optional transformer)		
Power consumption(kVA)	2.0 (Reference values)		
Air supply pressure(MPa)	0.5 ~ 0.7		
Average air consumption(L/min)	400		
N2 supply pressure(MPa)	0.3 ~ 0.5		
N2 average consumption(L/min)	30		
DI water supply pressure(MPa)	0.3 ~ 0.5		
Maximum DI water consumption flow rate(L/min)	6.0		
Exhaust (m3/min)	4.0 or more		
Dimensions WxDxH (mm)	1,645 x 1,680 x 1,800		
Machine weight (kg)	2,500		

*In addition to the above, a chiller unit and dust collector are included as ancillary equipment.

External View









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information

Contact

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